

ZXRE125
SOT23 MICROPOWER 1.22V VOLTAGE REFERENCE

Description

The ZXRE125 is a bandgap circuit designed to achieve a precision micropower voltage reference of 1.22 volts. The device is available in the small outline SOT23 surface mount package which is ideal for applications where space saving is important.

SOT23 tolerance is available to 0.5% for precision applications. Excellent performance is maintained over the 8µA to 20mA operating current range with a typical temperature coefficient of only 20ppm/°C. The device has been designed to be highly tolerant of capacitive loads so maintaining excellent stability.

This device offers a SOT23 pin for pin compatible replacement of the ZRA124 and ZRA125 series of voltage references.

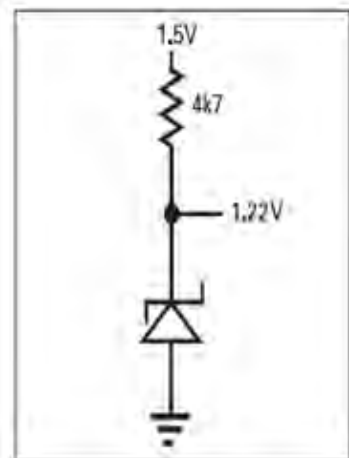
Features

- High performance 1.220V reference
- Small outline SOT23
- 4µA knee current
- 20ppm/°C typical temperature coefficient
- Unconditionally stable
- 0.5%, 1%, 2%, and 3% tolerance
- Green molding compound (No Br, Sb)

Applications

- Battery powered equipment
- Precision power supplies
- Portable instrumentation
- Portable communication devices
- Data acquisition systems

Application Circuit



Pin Assignments

SOT23 Package Suffix - F



(Top View)

Pin 1 floating or connected to pin 2

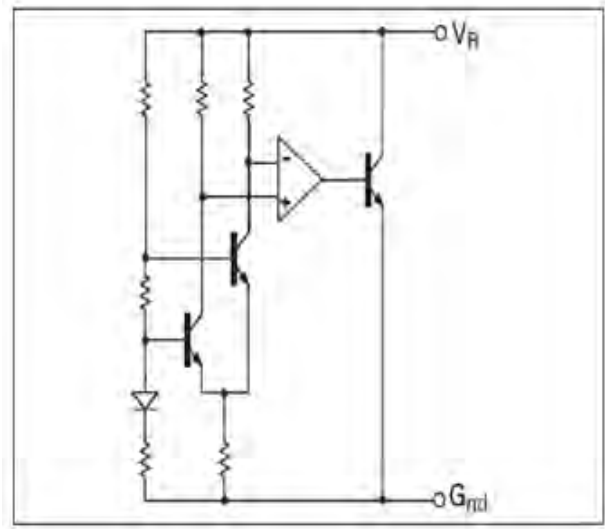
E-line
Package Suffix - R



(Bottom View)

Pin 3 floating or connected to pin 1

Schematic Diagram



Absolute Maximum Ratings (Voltages to GND Unless Otherwise Stated)

Parameter	Symbol	Rating	Unit
Reverse Current	V_Z	30	mA
Forward Current		10	mA
Operating Temperature	T_{OMP}	-40 to 85	°C
Storage Temperature	T_{STG}	-55 to 125	°C
Power Dissipation ($T_{AMB} = 25^{\circ}C$)	P_D	330	mW

Electrical Characteristics (Test conditions: $T_{amb} = 25^{\circ}C$, unless otherwise specified.)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Tol. (%)	Unit
V_R	Reverse breakdown voltage	$I_R = 100\mu A$	1.214 1.208 1.196 1.183	1.220 1.220 1.220 1.220	1.226 1.232 1.244 1.257	C/0.5 ⁽¹⁾ D/1 E/2 F/3	V
I_{MIN}	Minimum operating current			4	8		μA
I_R	Recommended operating current		0.008		20		mA
$T_C^{(*)}$	Average reverse breakdown voltage temperature coefficient	$I_{R(min)}$ to $I_{R(max)}$		20	75		ppm/°C
$\frac{\Delta V_R}{\Delta I_R}$	Reverse Breakdown Change with Current Voltage	$I_R = 30\mu A$ to 1mA $I_R = 1mA$ to 12mA			1 10		mV
Z_R	Reverse dynamic impedance	$I_R = 1mA$ $f = 100Hz$ $I_{AC} = 0.1I_R$		0.2	0.6		Ω
E_N	Wideband noise voltage	$I_R = 8\mu A$ to 100 μA $f = 10Hz$ to 10kHz		60			$\mu V(rms)$

Notes:

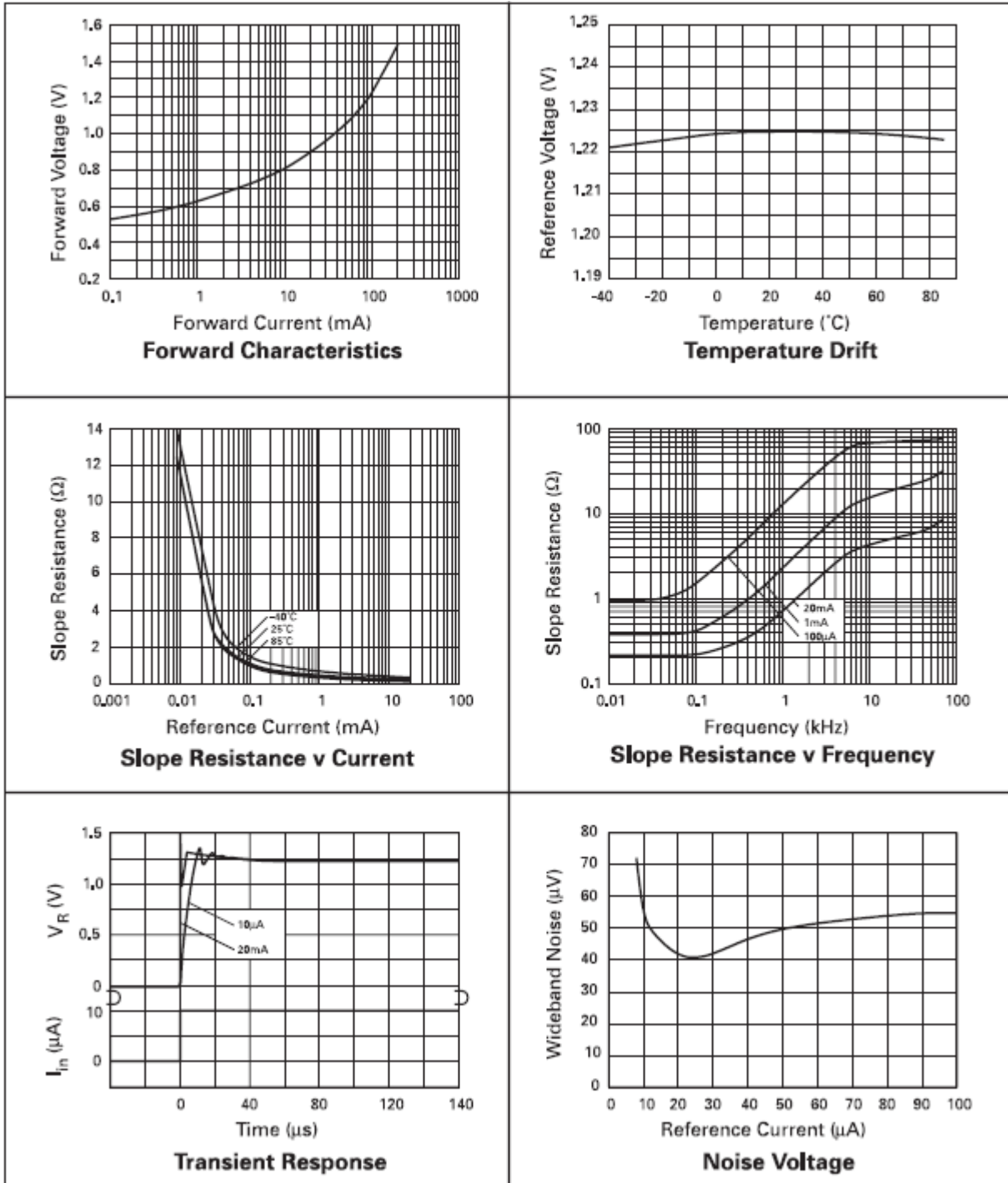
1.
$$(*) T_C = \frac{(V_{R(MAX)} - V_{R(MIN)}) \times 1000000}{V_R \times (T_{(MAX)} - T_{(MIN)})}$$

Note: $V_{R(MAX)} - V_{R(MIN)}$ is the maximum deviation in reference voltage measured over the full operating temperature range.

REVERSE CHARACTERISTICS



Typical Characteristics

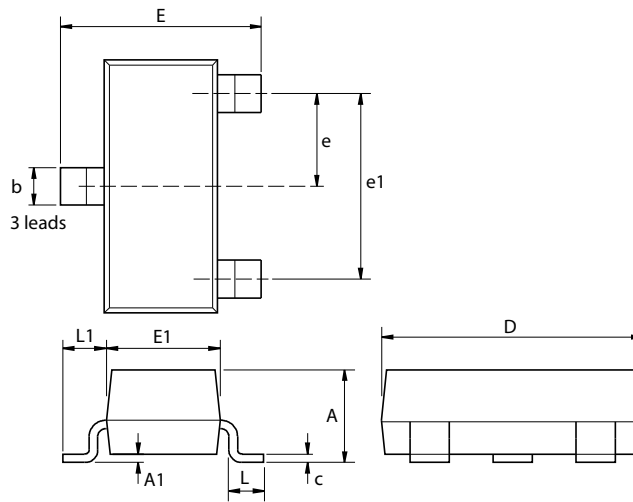


Ordering Information^(*)

Order Reference	Tol (%)	Device Mark	Grade	Status (*)	Reel Size (inches)	Quantity per reel	Tape Width (mm)
ZXRE125CFTA	0.5	12J	C	Released	7	3000	8
ZXRE125DFTA	1	12H	D	Released	7	3000	8
ZXRE125EFTA	2	12G	E	Released	7	3000	8
ZXRE125FFTA	3	12F	F	Released	7	3000	8

Notes: * All ZXRE125 E-line variants are obsolete and no longer available for sale.

Package Outline Dimensions



Dim.	Millimeters		Inches		Dim.	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	-	1.12	-	0.044	e1	1.90 NOM		0.075 NOM	
A1	0.01	0.10	0.0004	0.004	E	2.10	2.64	0.083	0.104
b	0.30	0.50	0.012	0.020	E1	1.20	1.40	0.047	0.055
c	0.085	0.20	0.003	0.008	L	0.25	0.60	0.0098	0.0236
D	2.80	3.04	0.110	0.120	L1	0.45	0.62	0.018	0.024
e	0.95 NOM		0.037 NOM		-	-	-	-	-

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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